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## 150W, S band High Power RF LDMOS FETs

### **Description**

The MC3515S is a 150watt, internally matched, single ended LDMOS FETs, designed for S band commercial application within 2700-3500MHz full band. It can be used in Class AB/B and Class C for any pulse CW signal

•Typical Performance (On Innogration fixture with device soldered):

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MC3515S VDS=28V Idq=200mA Vgs=2.5V Pulse 10% 100us						
F(MHz)	Pin (dBm)	Psat (dBm)	Psat (W)	I(A)	Gain (dB)	Eff(%)
2700	43	52.00	158	1.81	9.0	35.2
2800	42.1	52.00	158	1.74	9.9	36.8
2900	42.7	52.00	158	1.74	9.3	36.8
3000	43.5	52.00	158	1.75	8.5	36.5
3100	44	52.00	158	1.74	8.0	36.8
3200	43.8	52.00	158	1.64	8.2	39.3
3300	42.6	52.00	158	1.46	9.4	44.9
3400	42.8	52.00	158	1.44	9.2	45.6
3500	42.8	52.00	158	1.52	9.2	42.9

#### **Features**

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- · Excellent thermal stability, low HCl drift
- **Suitable Applications** 
  - S band pulse CW amplifier
  - ISM applications

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

### **Table 1. Maximum Ratings**

<del>-</del>			
Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	+65	Vdc
GateSource Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	V <sub>DD</sub>	+32	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	TJ	+225	°C

#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Rejc	0.2	°C/W
T <sub>C</sub> = 85°C, T <sub>J</sub> =200°C, DC test	Reju	0.2	-C/VV

#### **Table 3. ESD Protection Characteristics**

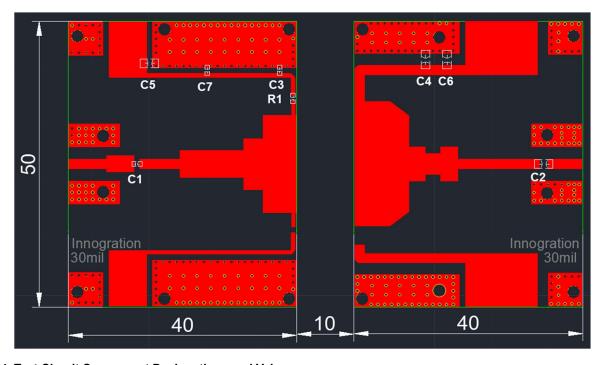
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Human Body Model (per JESD22A114)	Class 2	
Table 4 Floctrical Characteristics (T∆ = 25 °C unless otherwise noted)		

**Table 4. Electrical Characteristics** (TA = 25  $^{\circ}$ C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
DC Characteristics					
Zero Gate Voltage Drain Leakage Current				100	
$(V_{DS} = 65V, V_{GS} = 0 V)$	I <sub>DSS</sub>			100	μΑ
Zero Gate Voltage Drain Leakage Current				1	
$(V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V})$	I <sub>DSS</sub>			ı	μΑ
GateSource Leakage Current	I <sub>GSS</sub>			1	μΑ
$(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$	IGSS			ı	μΑ
Gate Threshold Voltage	V <sub>GS</sub> (th)		1.9		V
$(V_{DS} = 28V, I_D = 450 \mu A)$	V GS(U1)		1.0		v
Gate Quiescent Voltage	$V_{GS(Q)}$		2.4		V
$(V_{DD} = 28 \text{ V}, I_D = 100 \text{ mA}, \text{ Measured in Functional Test})$	▼ GS(Q)		2.7		v

Figure 1. Test Circuit Component Layout

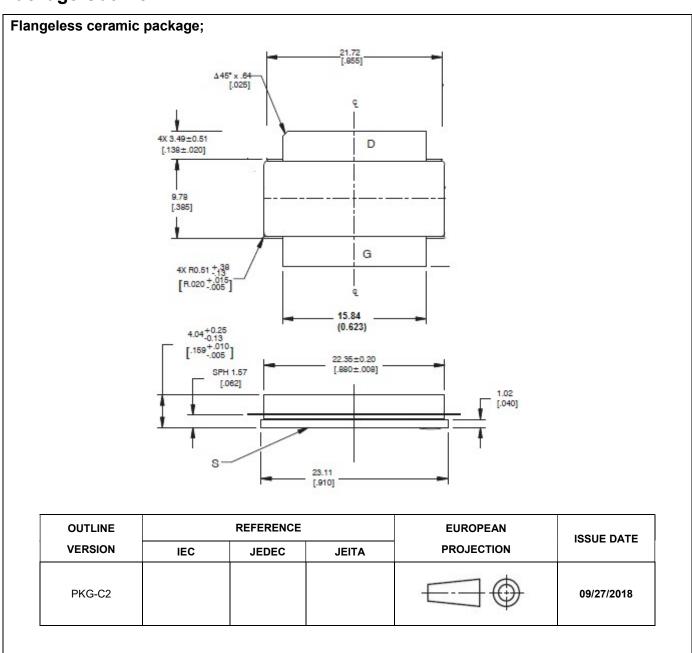


**Table 4. Test Circuit Component Designations and Values** 

Part	description	Model
R1	7.50Ω	Chip Resistor
C1 ,C3	10pF 600F	
C2	15pF ATC 800R	
C4	12pF MQ10111	

C7	0.5PF MQ10111	
C5,C6	10uF 1210	
PCB	20mil Rogers43	50B

## **Package Outline**



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### **Revision history**

Table 5. Document revision history

Date	Revision	Datasheet Status
2023/5/24	Rev 1.0	Product Datasheet Creation

Application data based on SXY-23-20

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